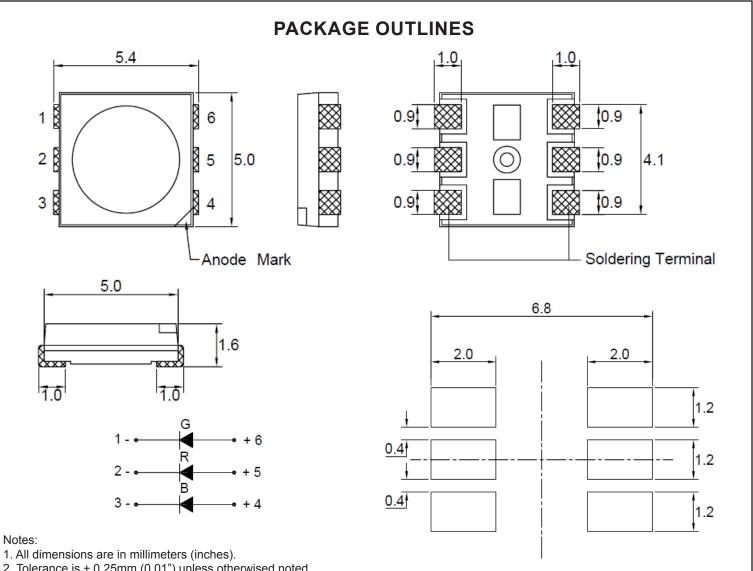


## **SPECIFICATION**

# CSPT224R2B2GT2C



2. Tolerance is ± 0.25mm (0.01") unless otherwised noted.

3. Specifications are subject to change without notice.

Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle
	InGaAIP	Red	Water Clear	120°
CSPT224R2B2GT2C	InGaN	Blue	Water Clear	120°
	InGaN	Green	Water Clear	120°





## **ABSOLUTE MAXIMUM RATINGS**

### (TA=25°C)

		Max R			
Parameter	Symbol	Blue/ Green	Red	Unit	
Forward Current	lF	30 50		mA	
Reverse Voltage	VR	5 5		V	
Power Dissipation	Pd	108	130	mW	
Operating Temperature Range	Тор	-20~+80		°C	
Storage Temperature Range	Тѕтс	-30~+	-100	°C	
Peak Pulsing Current (tp $\leq$ 10 $\mu$ S, duty cycle = 0.005)	lfp	100	90	mA	

# OPTICAL-ELECTRICAL CHARACTERISTICS

(TA=25°C)

Deremeter	Symbol	Test Condition	Color	Value			Lipit
Parameter				Min	Тур	Max	Unit
			Red	500	800	-	
Luminous Intensity	lv	IF = 20mA	Green	800	1250	-	mcd
			Blue	125	320	-	
Forward Voltage	VF	IF = 20mA	Red	-	2.2	2.6	V
			Green	-	3.2	3.6	
			Blue	-	3.2	3.6	
Viewing Angle at 50% Iv	201/2	IF = 20mA	-	-	120	-	Deg
	λD	IF = 20mA	Red	-	624	-	
Dominant Wavelength			Green	-	525	-	nm
			Blue	-	470	-	

\*Tolerance of viewing angle: -10 / +5 deg.

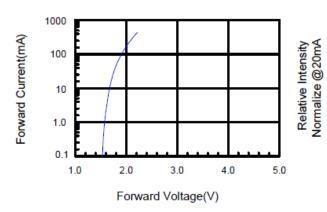
\*Tolerance of forward voltage is -/+ 0.05V

\*Tolerance of luminous intensity -/+ 1nm





### TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVES (RED)



### Fig.1 Forward current vs. Forward Voltage



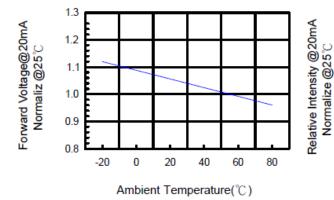


Fig.5 Relative Intensity vs. Wavelength

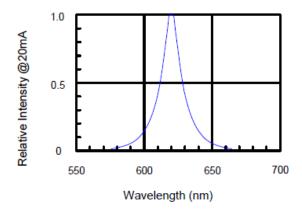


Fig.2 Relative Intensity vs. Forward Current

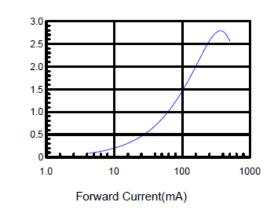
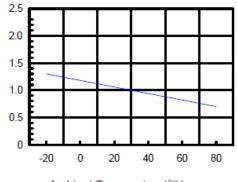
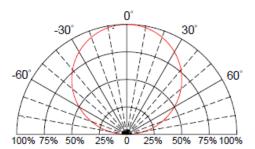


Fig.4 Relative Intensity vs. Temperature



Ambient Temperature(℃)

#### Fig.6 Directive Radiation







# TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVES (GREEN)

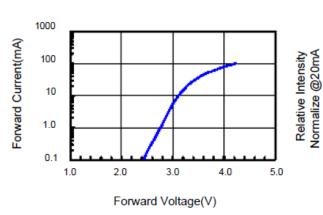


Fig.1 Forward current vs. Forward Voltage

> 0.5 0.0

> > 1.0

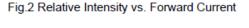


Fig.4 Relative Intensity vs. Temperature

10

100

Forward Current(mA)

1000

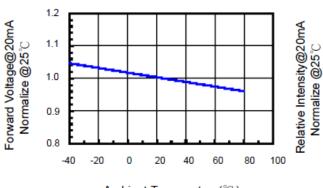
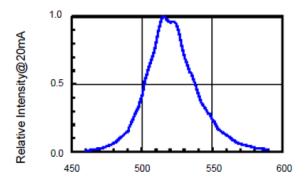


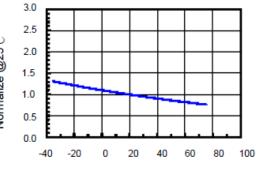
Fig.3 Forward Voltage vs. Temperature

Ambient Temperature(°C)

Fig.5 Relative Intensity vs. Wavelength

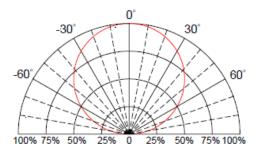


Wavelength (nm)



Ambient Temperature(°C)

#### Fig.6 Directive Radiation







# **TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVES (BLUE)**

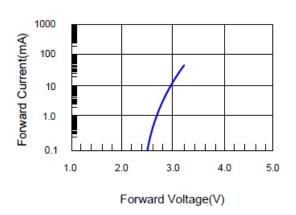


Fig.1 Forward current vs. Forward Voltage

#### Fig.3 Forward Voltage vs. Temperature

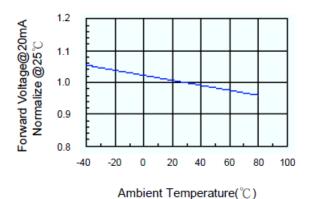
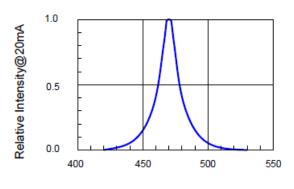
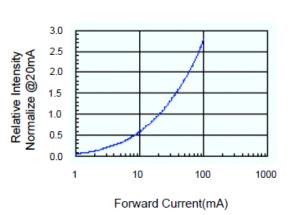


Fig.5 Relative Intensity vs. Wavelength

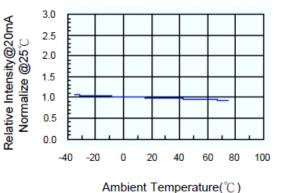


Wavelength (nm)



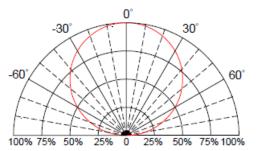
#### Fig.2 Relative Intensity vs. Forward Current

Fig.4 Relative Intensity vs. Temperature



Ambient Temperature( ()

#### Fig.6 Directive Radiation





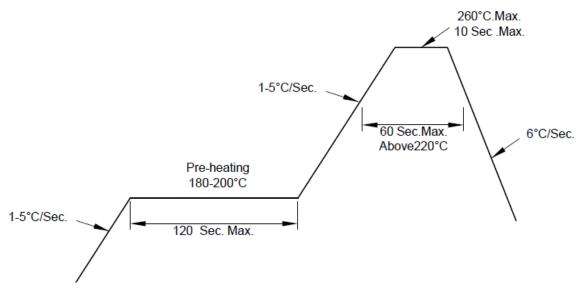




## **SOLDERING CONDITIONS**

Pb-Free solder temperature profile

Pb -free solder Temperature profile			
Pre-heat	180-200°C		
Pre-heat time	120 Sec Max		
Peak-Temperature	260°C Max		
Soldering time condition	10 Sec Max		



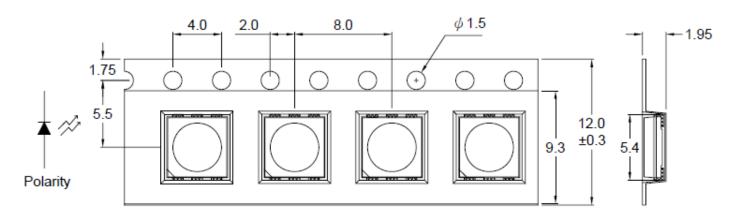
- Repairing should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used. It should be confirmed beforehand whether the Characteristics of the LEDs will or will not be damaged by repairing.
- Reflow soldering should not be done more than two times.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.



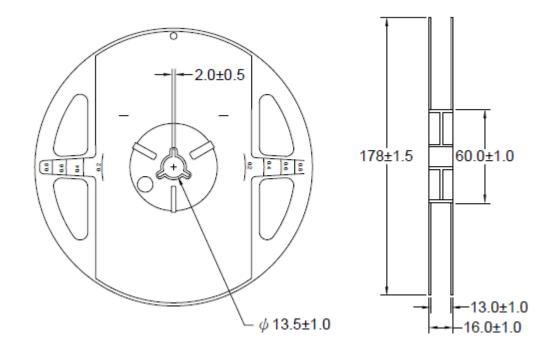


# REEL PACKAGING

### **CARRIER TAPE DIMENSIONS**



### **REEL DIMENSION**



#### Notes:

- 1. 12.0mm tape, 7" Reel; 1,000 pcs/reel
- 2. Tolerance unless mentioned is  $\pm 0.2$ mm

